ESD108-B1-CSP0201

Bi-directional ESD protection device, 5.5 V, 0.28 pF, 0201

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Product description

This Infineon ESD (electrostatic discharge) protection device has a bi-directional and symmetric *I*/*V* characteristic and excellent clamping performance

Feature list

- ESD / transient protection according to:
  - IEC61000-4-2 (ESD): ±25 kV (air) / ±25 kV (contact)
  - IEC61000-4-4 (EFT): ±2.5 kV / ±50 A (5/50 ns)
  - IEC61000-4-5 (Surge): ±2.5 A (8/20 µs)
- Bi-directional maximum working voltage: V_{WM} = ±5.5 V
- Line capacitance: C_L = 0.28 pF at f = 1 MHz
- Clamping voltage: V_{cl} = 20 V at I_{TLP} = 16 A with R_{dyn} = 0.78 Ω
- Very low leakage current: I_L =0.1 nA
- Small form factor SMD size 0201, low profile (0.58 x 0.28 x 0.15 mm^3)

Potential applications

- USB 3.x Gen. 1, USB 2.0
- HDMI, DisplayPort

Product validation

Qualified for industrial applications according to the relevant tests of JEDEC47/20/22.

Device information

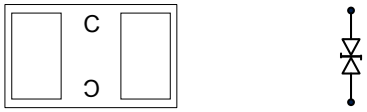

Figure 1 **Pin configuration with marking (bottom view)**

Table 1 **Part information**

Product name / Ordering code	Package	Pin configuration	Marking	Pieces / Reel
ESD108-B1-CSP0201 / ESD108B1CSP0201XTSA1	WLL-2-1	1 line, bi-directional	C	15 k

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1 Absolute maximum ratings

Table 2 Absolute maximum ratings at T_A = 25°C, unless otherwise specified

Parameter	Symbol	Values		Unit	Note or test condition
		Min.	Max.		
Working voltage	V_{WM}	-5.5	+5.5	V	
Working current	I_{WM}	-10	+10	mA	Device mounted on PCB with R_{th} = 200 K/W
ESD discharge voltage	V_{ESD} (contact)	-25	+25	kV	Discharge network: R = 330 Ω, C = 150 pF [1)]
	V_{ESD} (air)	-25	+25		
Peak pulse power	P_{PK}	–	1800	W	t_p = 100 ns
		–	27.5		t_p = 8/20 µs waveform [2)]
Peak pulse current	I_{PP}	-2.5	+2.5	A	t_p = 8/20 µs waveform [2)]
Operating temperature	T_{op}	-55	+125	°C	
Storage temperature	T_{stg}	-65	+150		

Attention**: **Stresses above the maximum values listed here may cause permanent damage to the device. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Maximum ratings are absolute ratings. Exceeding only one of these values may cause irreversible damage to the component.

1 Based on IEC61000-4-2.
2 Based on IEC61000-4-5.

2 Electrical characteristics

Note: *T_A = 25°C, unless otherwise specified. Device is electrically symmetrical.*

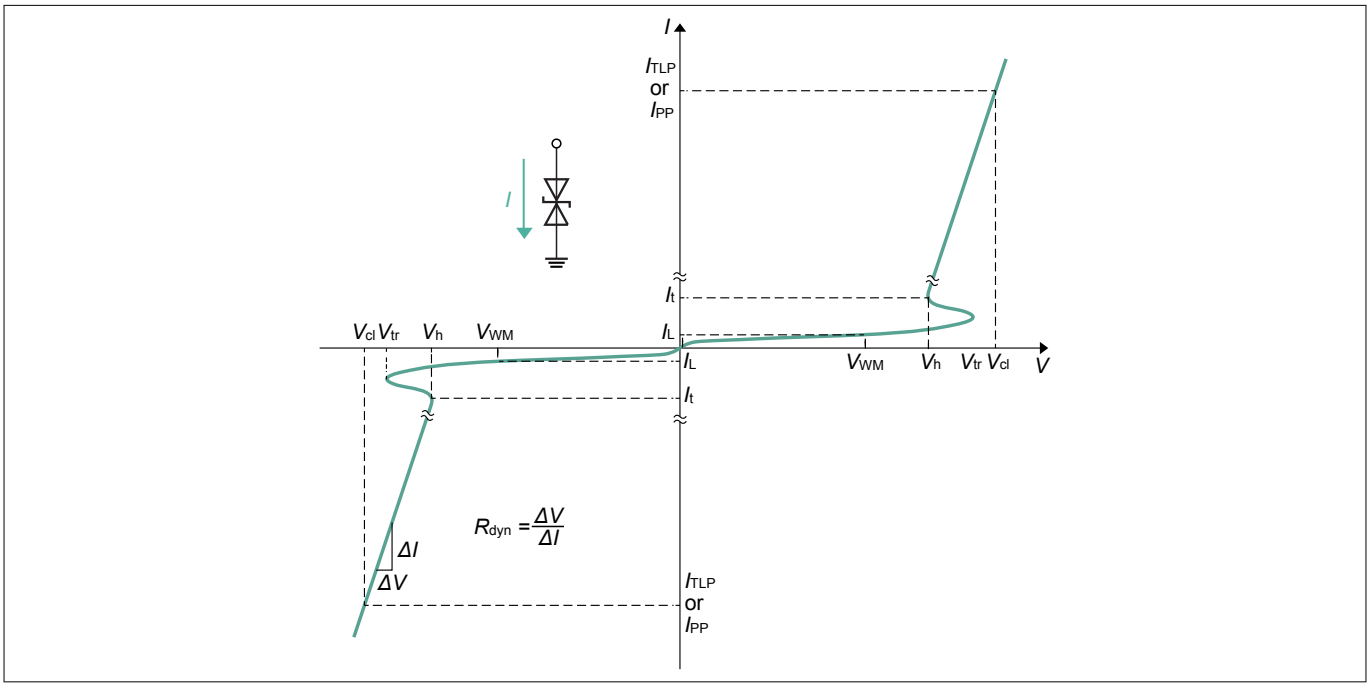

Figure 2 ***I/V* characteristic curve**

Table 3 ***I/V* characteristic parameters**

Symbol	Parameter
I_h	Holding current
I_L	Leakage current
I_{PP}	Peak pulse current, based on IEC61000-4-5
I_t	Test current
I_{TLP}	TLP current
R_{dyn}	Dynamic resistance
V_{cl}	Clamping voltage
V_h	Holding voltage
V_t	Test voltage
V_{tr}	Trigger voltage
V_{WM}	Maximum working voltage

2 Electrical characteristics

Table 4 DC characteristics

Parameter	Symbol	Values			Unit	Note or test condition
		Min.	Typ.	Max.		
Trigger voltage [3]	V_{tr}	–	9.5	12.5	V	
Holding voltage	V_h	5.5	6.5	9.5		I_t = 0.5 mA
		6.1	7.5	9.0		I_t = 1 mA
Leakage current	I_L	–	0.1	20	nA	V_{WM} = 5.5 V

Table 5 AC characteristics

Parameter	Symbol	Values			Unit	Note or test condition
		Min.	Typ.	Max.		
Line capacitance	C_L	–	0.28	0.38	pF	V = 0 V, f = 1 MHz
		–	0.22	0.38		V = 0 V, f = 1 GHz
Series inductance	L_S	–	<0.1	–	nH	Extracted from S-parameters

Table 6 Protection characteristics

Parameter	Symbol	Values			Unit	Note or test condition
		Min.	Typ.	Max.		
Clamping voltage (TLP) [4] [5]	V_{cl}	–	11	–	V	I_{TLP} = 4 A
		–	14.2	–		I_{TLP} = 8 A
		–	20	27		I_{TLP} = 16 A
		–	30.5	41		I_{TLP} = 30 A
Clamping voltage (8/20 µs) [6]		–	8.5	12		I_{PP} = 1 A
		–	11	18.5		I_{PP} = 2.5 A
Dynamic resistance [4]	R_{dyn}	–	0.78	–	Ω	

3 Verified by design.
4 TLP parameters: Z_0 = 50 Ω, t_p = 100 ns, t_r = 0.6 ns, averaging window 30-60 ns.
5 Refer to application note AN210 *[2]*
6 t_p = 8/20 µs. Stress pulse based on IEC61000-4-5.

3 Thermal characteristics

Table 7 Thermal resistance

Parameter	Symbol	Values		Unit	Note or Test Condition
		Min.	Max.		
Thermal resistance	R_{thJS}	–	330	K/W	Junction - soldering point

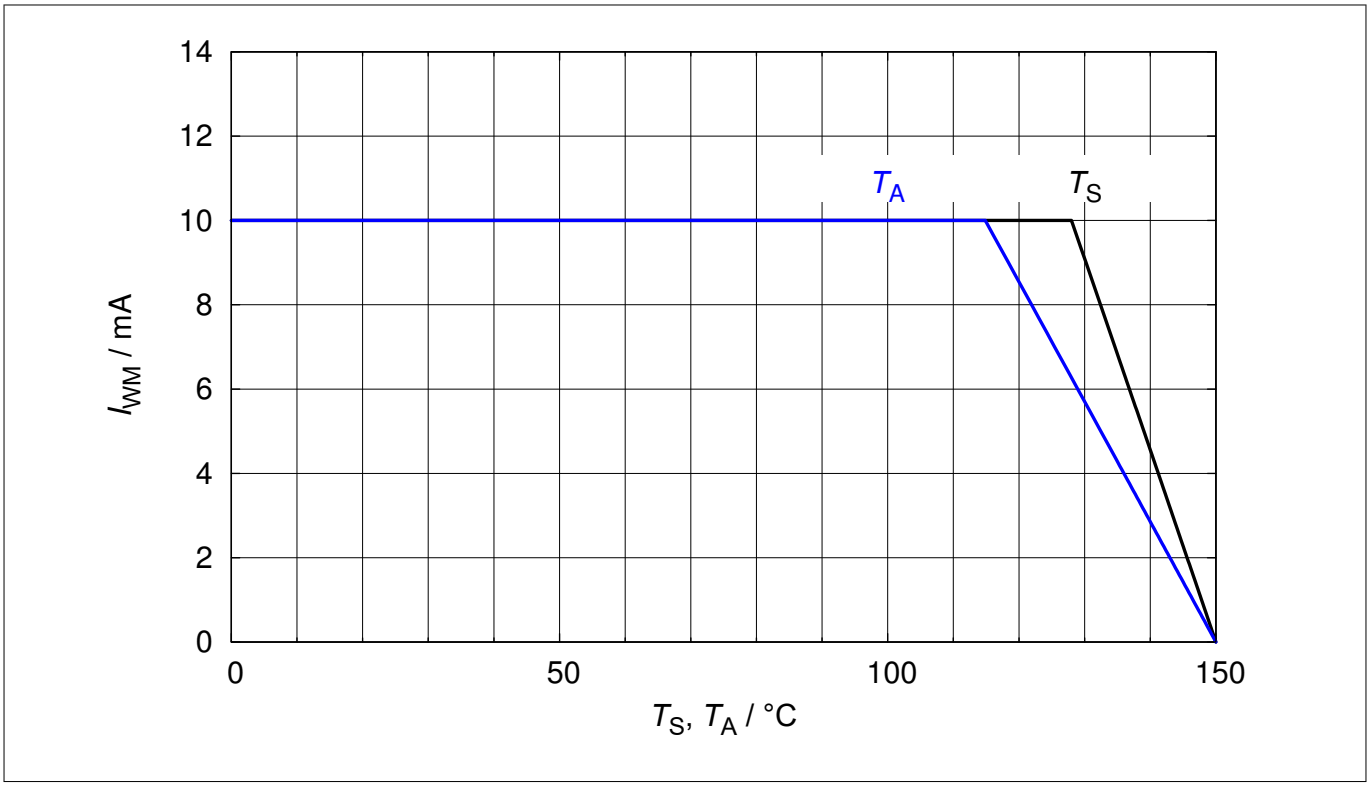

Figure 3 Maximal working current: I_{WM} = f(T_S, T_A), device mounted on PCB with R_{th} = 200 K/W

4 Typical characteristic diagrams

Note: *T_A = 25 °C, unless otherwise specified.*

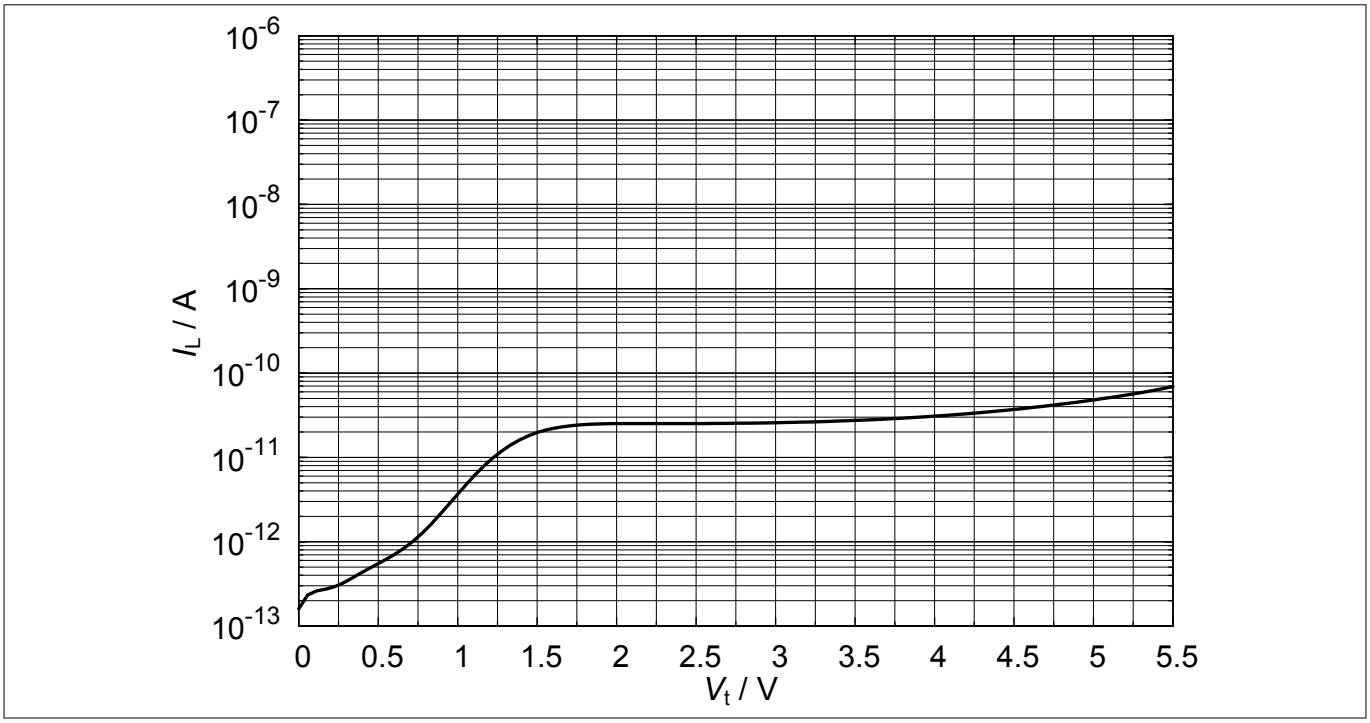

Figure 4 **Leakage current: I_L = f(V_t)**

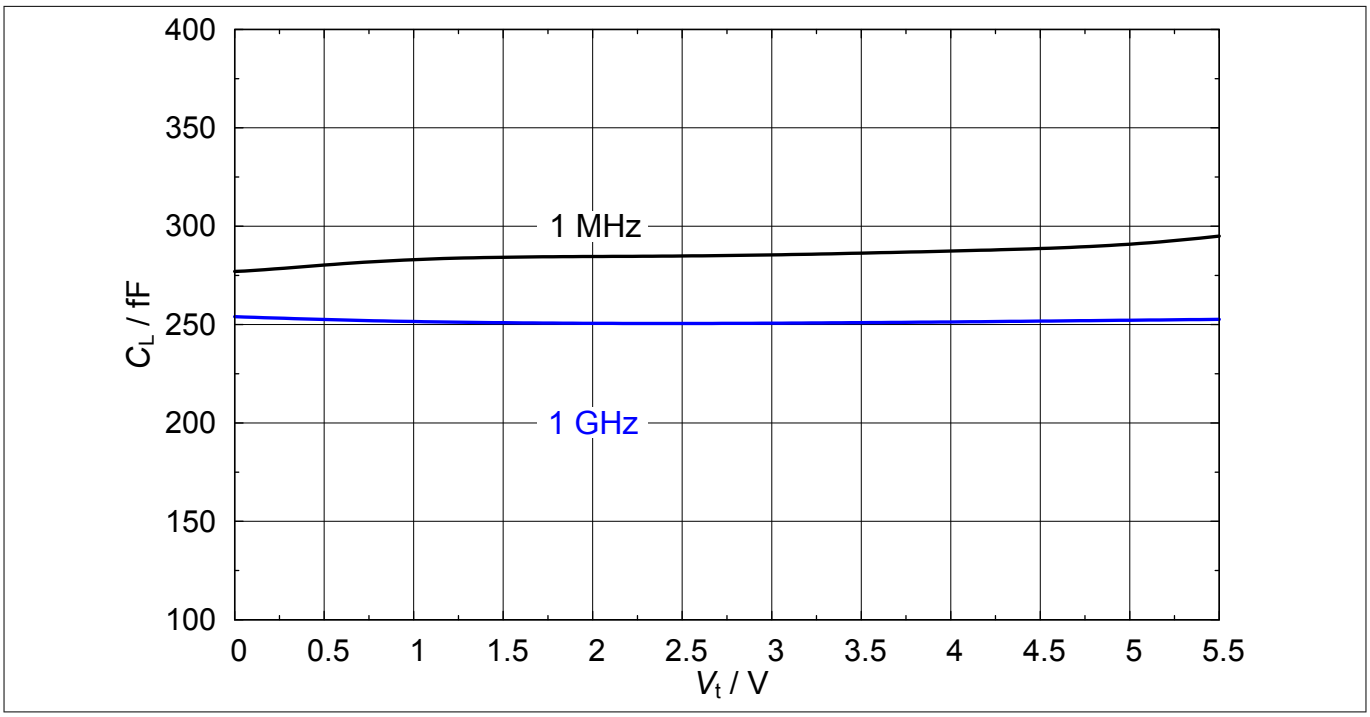

Figure 5 **Line capacitance: C_L = f(V_t), f = 1 MHz, 1 GHz**

4 Typical characteristic diagrams

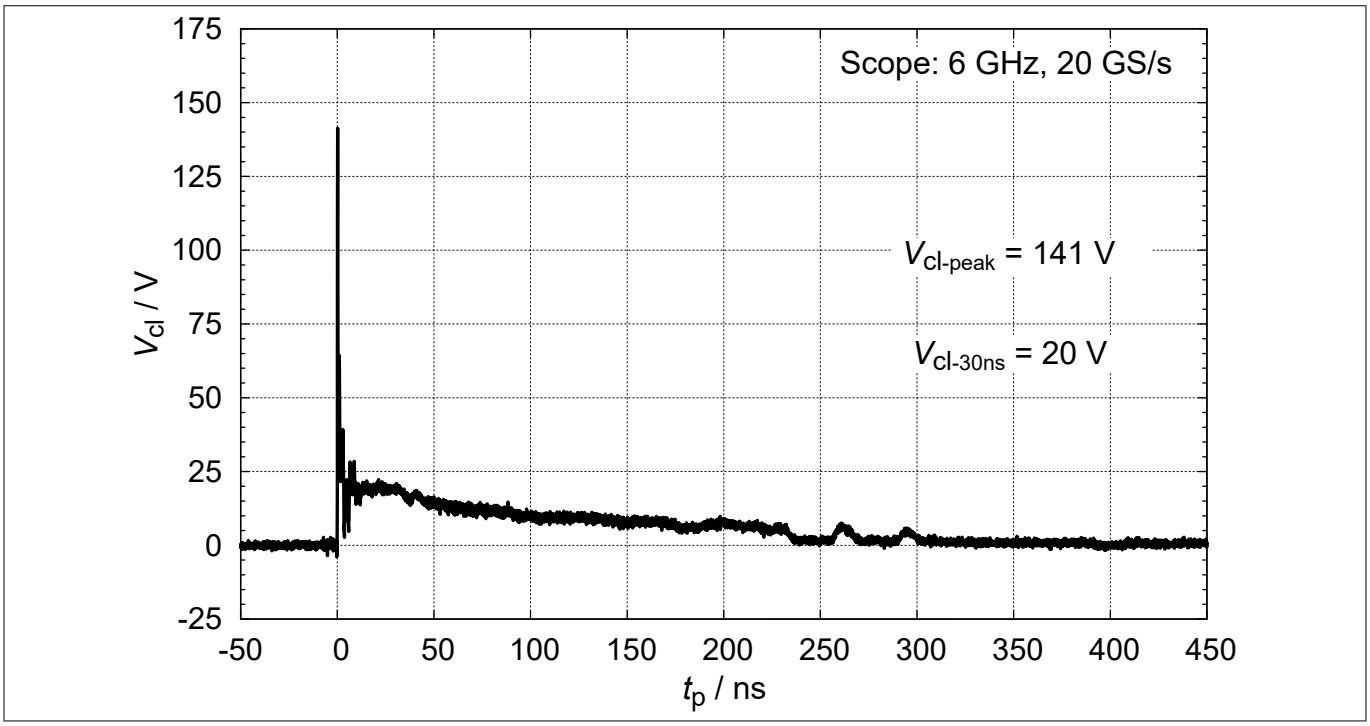

Figure 6 **Clamping voltage (ESD): V_{cl} = f(t_p), 8 kV positive pulse based on IEC61000-4-2**

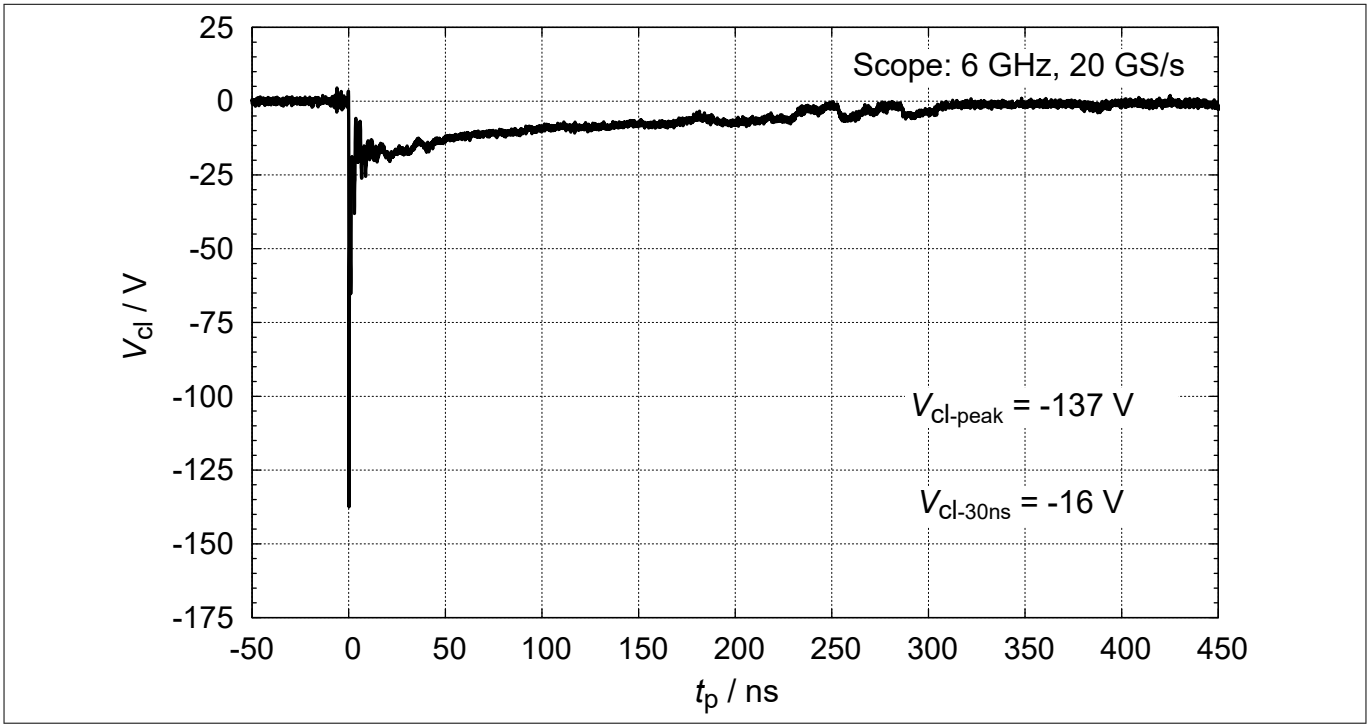

Figure 7 **Clamping voltage (ESD): V_{cl} = f(t_p), 8 kV negative pulse based on IEC61000-4-2**

4 Typical characteristic diagrams

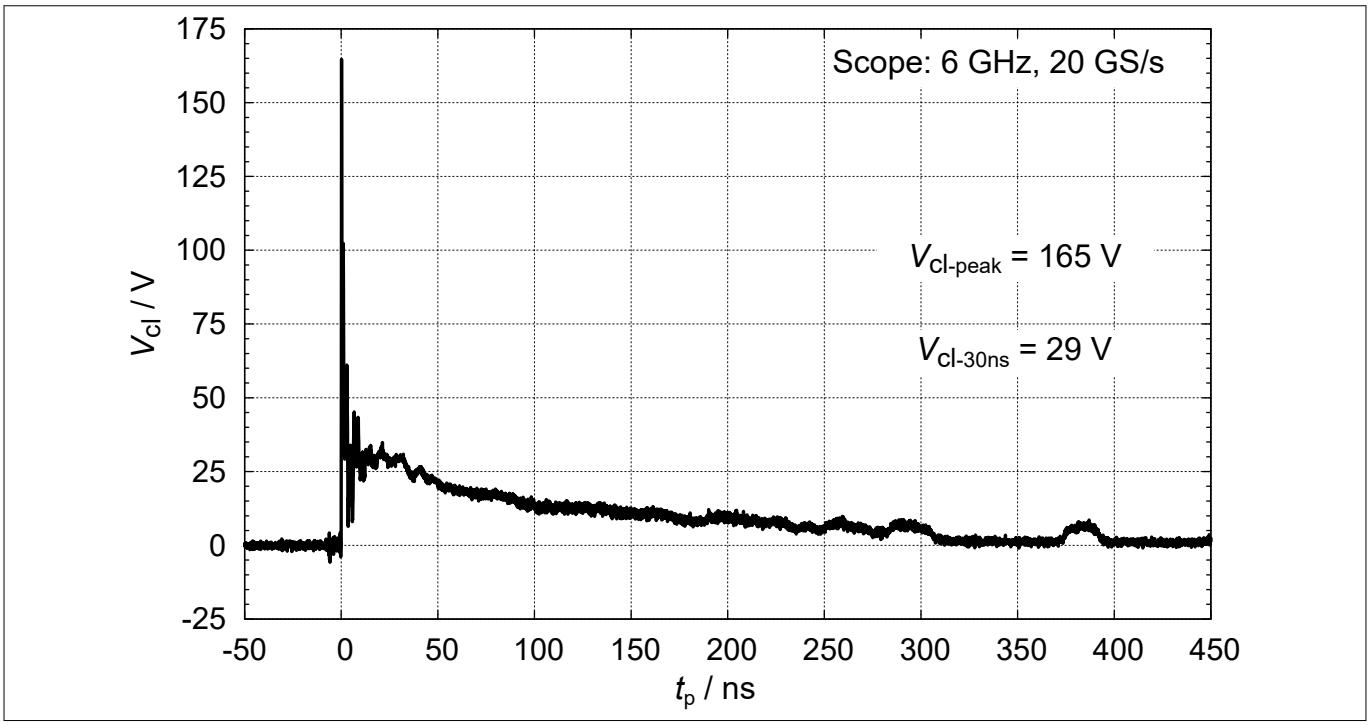

Figure 8 **Clamping voltage (ESD): V_{cl} = f(t_p), 15 kV positive pulse based on IEC61000-4-2**

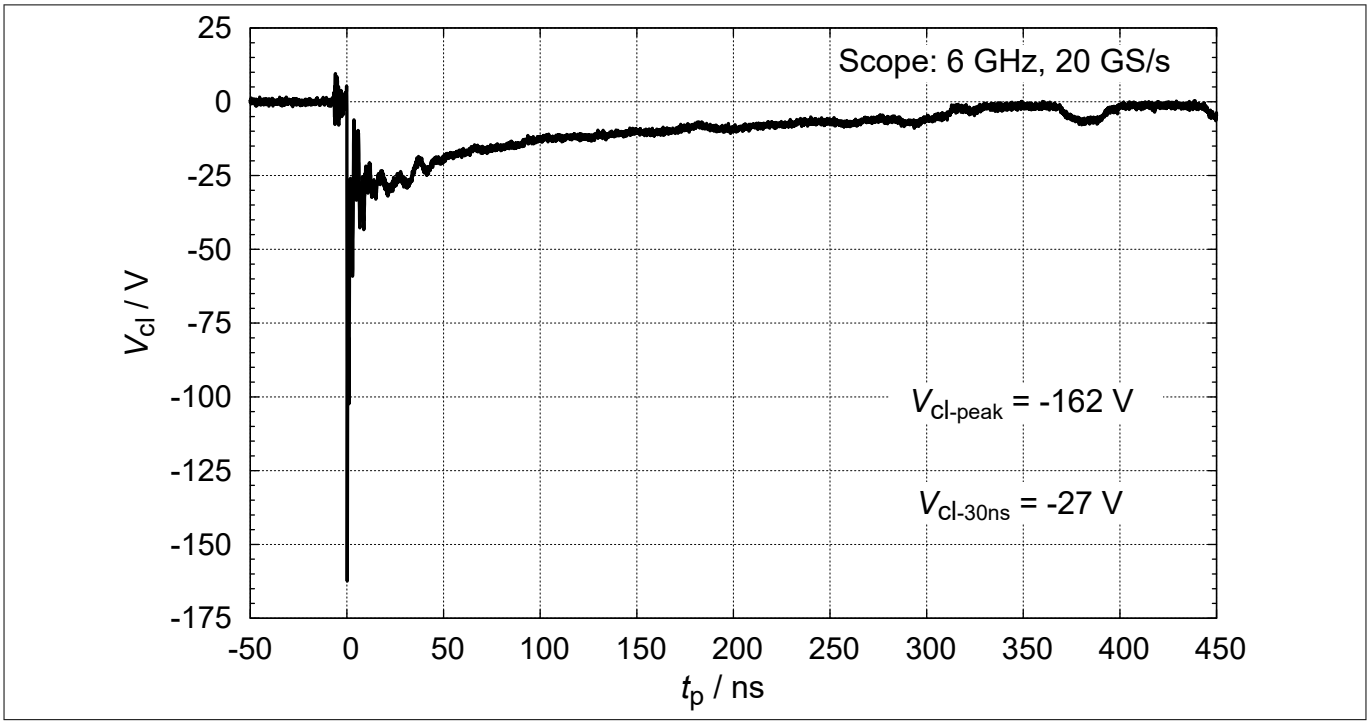

Figure 9 **Clamping voltage (ESD): V_{cl} = f(t_p), 15 kV negative pulse based on IEC61000-4-2**

4 Typical characteristic diagrams

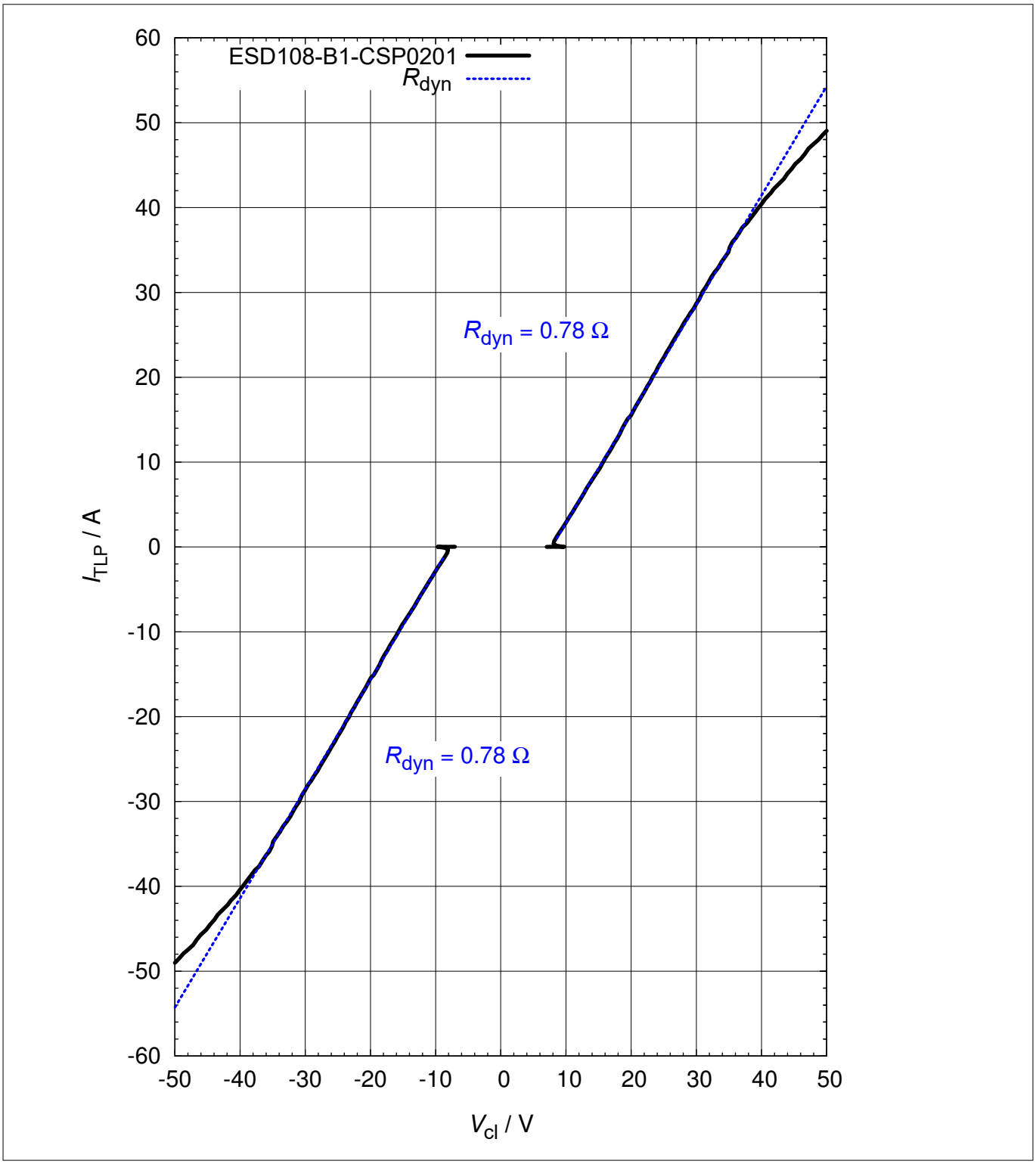

Figure 10 **Clamping voltage (TLP): I_{TLP} = f(V_{cl})**

4 Typical characteristic diagrams

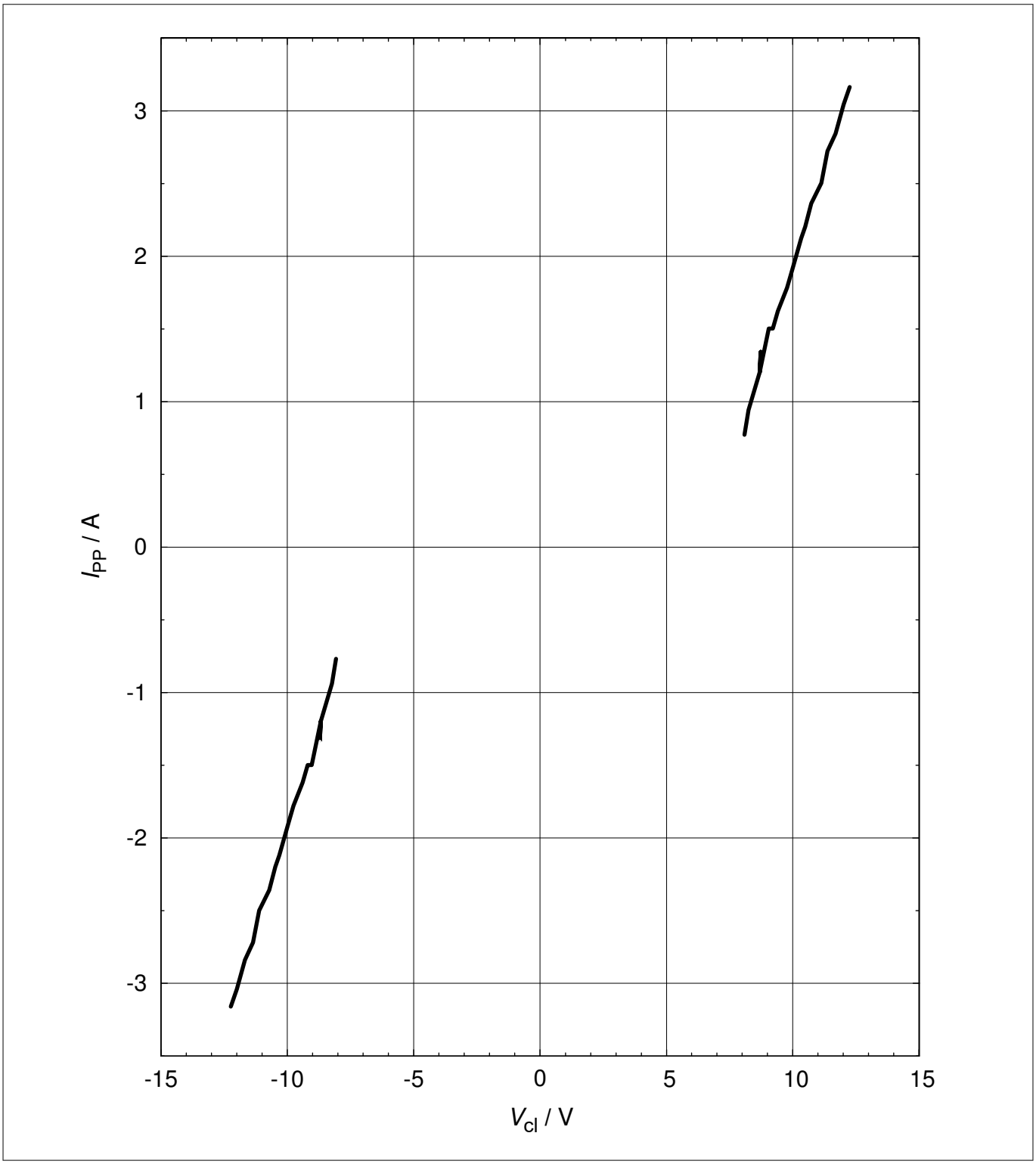

Figure 11 **Clamping voltage (Surge): I_{PP} = f(V_{cl}), based on IEC61000-4-5**

4 Typical characteristic diagrams

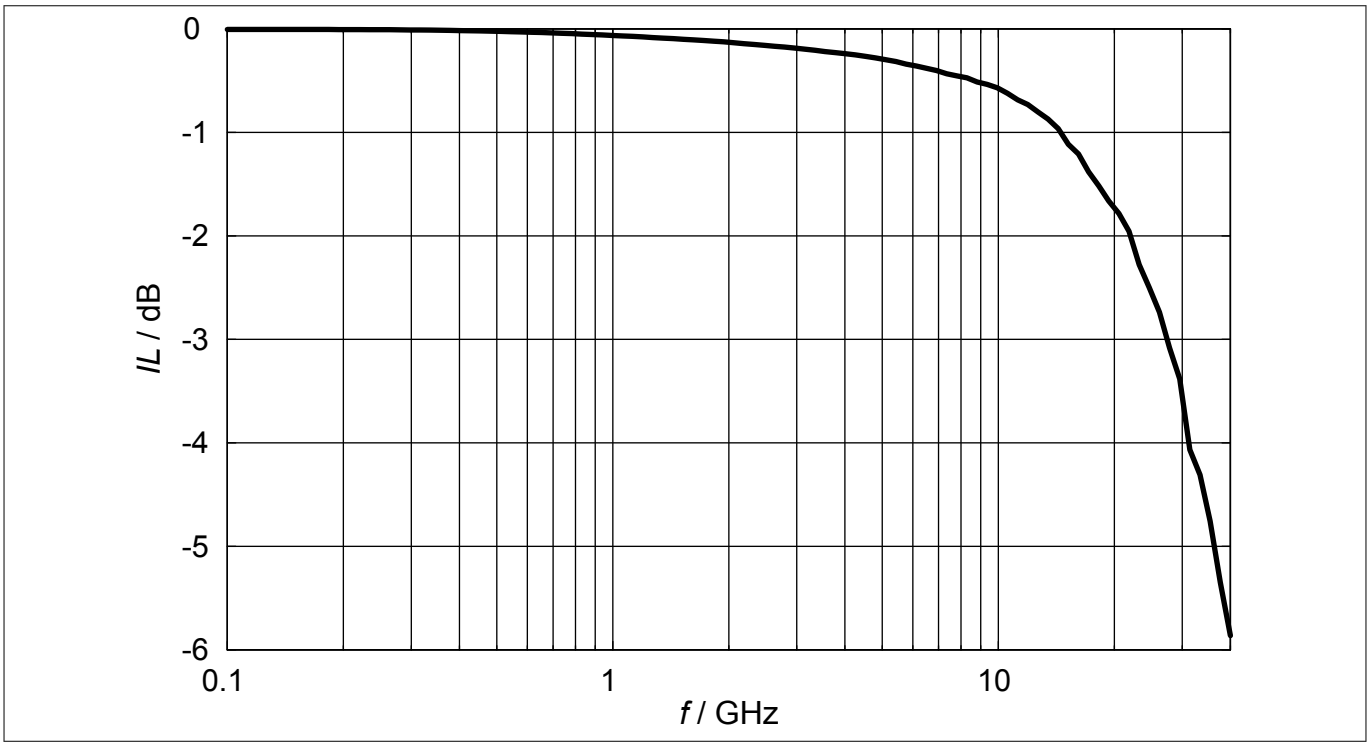

Figure 12 **Insertion loss *IL* = f(*f*), measured in a 50 Ω system**

5 Package information WLL-2-1

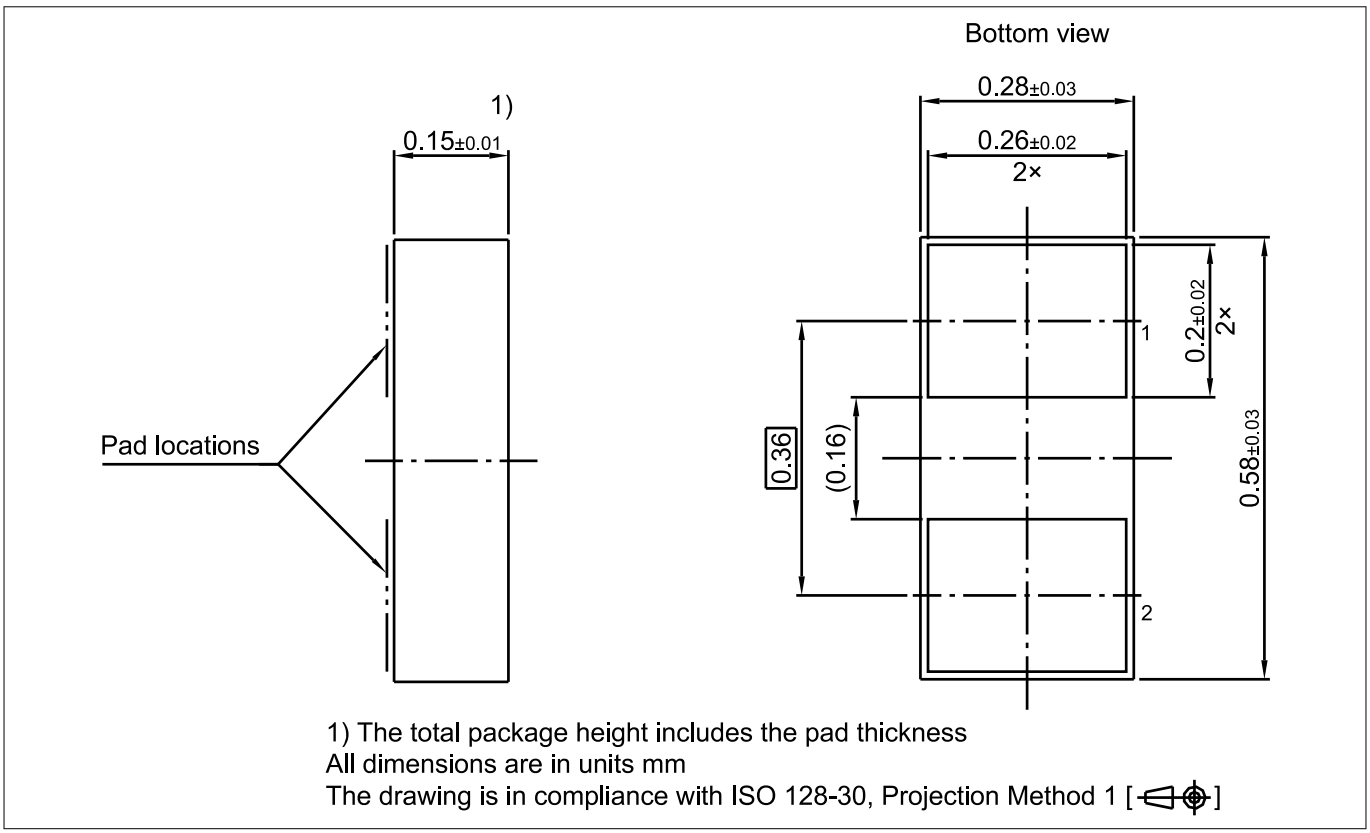

Figure 13 WLL-2-1 package

Note: For package information including footprint, packing and assembly recommendation refer to:

https://www.infineon.com/packages/SG-WLL-2-1/

6 References

[1]	Infineon AG - Understanding ESD protection device characteristics
[2]	Infineon AG - **Application note AN210**: Effective ESD Protection Design at System Level Using VF-TLP Characterization Methodology

7 Revision history

Document version	Date of release	Description of changes
v2.0	2020-07-30	• New datasheet layout and values updated.

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